



Atty. Dkt. No. 047711-0319

**THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Rajiv SHAH et al.

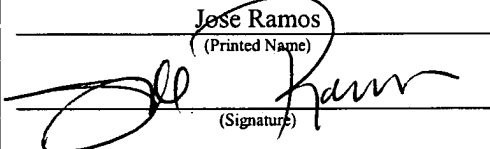
Title: HIGH RELIABILITY MULTILAYER  
CIRCUIT SUBSTRATES AND  
METHODS FOR THEIR  
FORMATION

Appl. No.: 10/671,996

Filing Date: 9/26/2003

Examiner: Long Pham

Art Unit: 2814

<b>CERTIFICATE OF EXPRESS MAILING</b>	
I hereby certify that this correspondence is being deposited with the United States Postal Service's "Express Mail Post Office To Addressee" service under 37 C.F.R. § 1.10 on the date indicated below and is addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.	
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Jose Ramos	
(Printed Name)	
	
(Signature)	

**AMENDMENT AND RESPONSE TO OFFICE ACTION UNDER 37 C.F.R. 1.111**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This communication is responsive to the non-final Office Action dated August 22, 2005, concerning the above-referenced patent application. Included herein is a Petition for extension of time, extending the period for response to the above-referenced Office Action by two (2) months to January 22, 2006.

Please amend the application as follows:

01/25/2006 NNGUYEN1 00000101 10671996

01 FC:1201 200.00 OP

01/25/2006 NNGUYEN1 00000101 10671996

02 FC:1252 450.00 OP